

Part Number: APT1608SYCK-AMT

Super Bright Yellow

### Features

- High reliability LED package.
- 1.6mmx0.8mm SMT LED, 0.75mm thickness
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

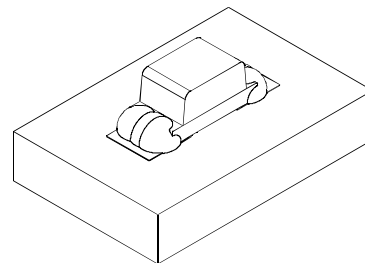
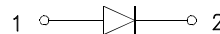
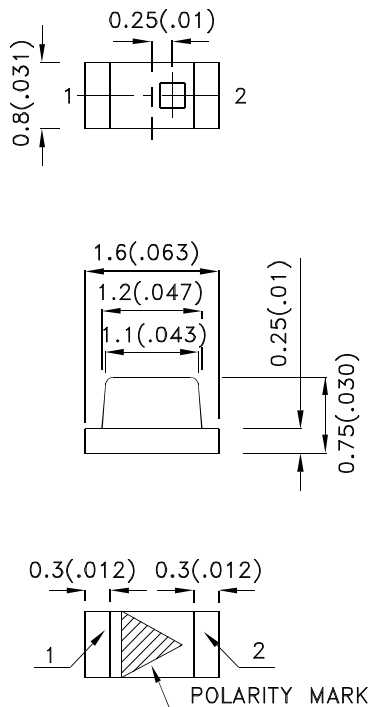
### Description

The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

### Applications

- Traffic signaling.
- Backlighting (illuminated advertising , general lighting).
- Interior and exterior automotive lighting.
- Substitution of micro incandescent lamps.
- Reading lamps.
- Signal and symbol luminaire for orientation.
- Marker lights (e.g. Steps, exit ways, etc).
- Decorative and entertainment lighting.
- Indoor and outdoor commercial and residential architectural lighting.

### Package Dimensions



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.1(0.004)$  unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



## Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA			Viewing Angle [1]
			Code.	Min.	Max.	2θ1/2
APT1608SYCK-AMT	Super Bright Yellow (AlGaInP)	Water Clear	N	120	200	120°
			P	200	300	
			Q	300	400	
			R	400	500	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.

## Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	P <sub>D</sub>	75	mW
Reverse Voltage	V <sub>R</sub>	5	V
Junction temperature	T <sub>J</sub>	120	°C
Operating Temperature	T <sub>op</sub>	-40 To +100	°C
Storage Temperature	T <sub>stg</sub>	-40 To +120	°C
DC Forward Current[1]	I <sub>F</sub>	30	mA
Peak Forward Current [2]	I <sub>FM</sub>	175	mA
Electrostatic Discharge Threshold (HBM)		3000	V
Thermal Resistance (Junction/ambient) [1]	R <sub>th(j-a)</sub>	350	°C/W

Notes:

1. R<sub>th(j-a)</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad),
2. 1/10 Duty Cycle, 0.1ms Pulse Width.

## Electrical / Optical Characteristics at Ta=25°C

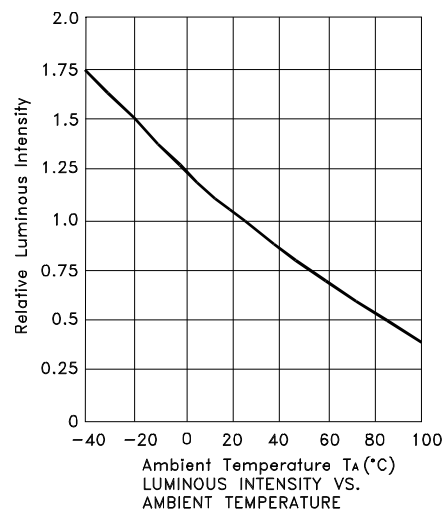
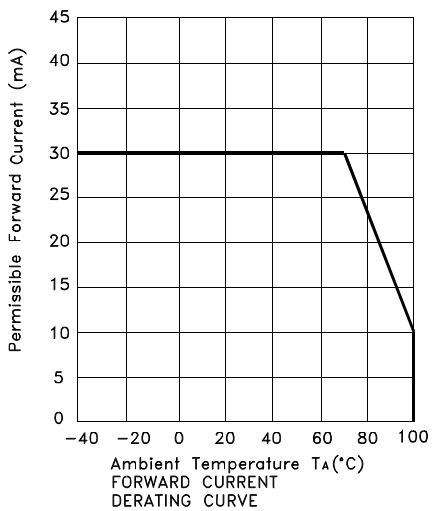
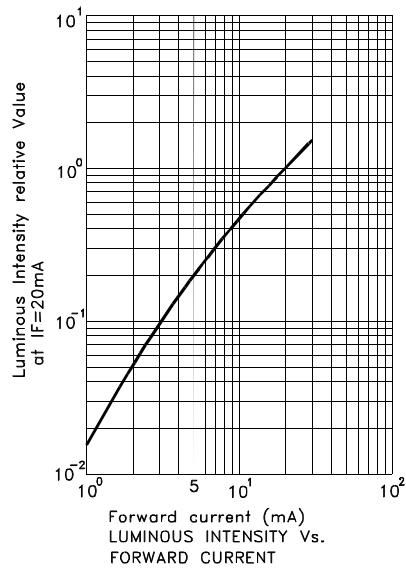
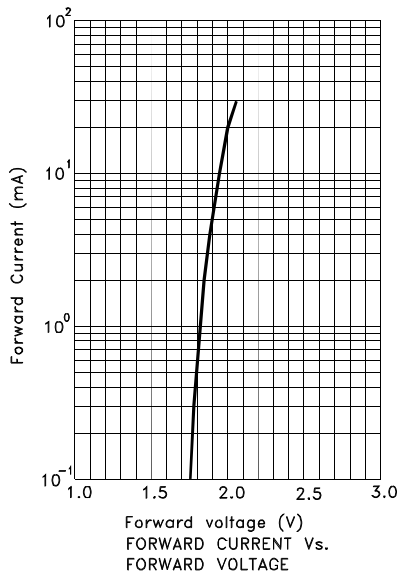
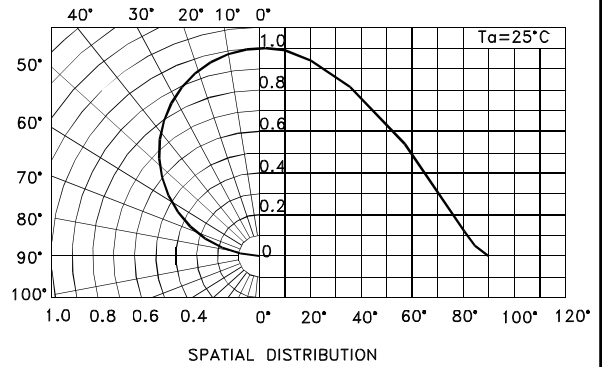
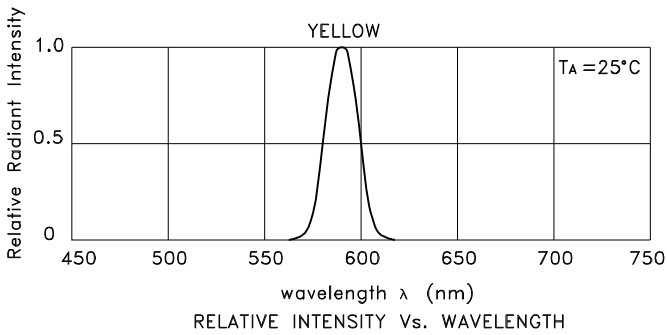
Parameter	Symbol	Value				Unit
		Code.	Min.	Typ.	Max.	
Wavelength at peak emission I <sub>F</sub> =20mA	λ peak			590		nm
Dominant Wavelength I <sub>F</sub> =20mA	λ dom [1]	2	584		586	nm
		3	586		588	
		4	588		590	
		5	590		592	
Spectral bandwidth at 50%Φ REL MAX I <sub>F</sub> =20mA	Δλ			20		nm
Forward Voltage I <sub>F</sub> =20mA	V <sub>F</sub> [2]			2.0	2.5	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>				10	uA
Temperature coefficient of λ peak I <sub>F</sub> =20mA, -10 ° C ≤ T ≤ 100 ° C	TC λ peak			0.13		nm/° C
Temperature coefficient of λ dom I <sub>F</sub> =20mA, -10 ° C ≤ T ≤ 100 ° C	TC λ dom			0.04		nm/° C
Temperature coefficient of V <sub>F</sub> I <sub>F</sub> =20mA, -10 ° C ≤ T ≤ 100 ° C	TC <sub>V</sub>			-1.9		mV/° C

Notes:

1. The dominant Wavelength (λ<sub>d</sub>) above is the setup value of the sorting machine. (Tolerance λ<sub>d</sub> : ±1nm. )
2. Forward Voltage: +/-0.1V.

## Super Bright Yellow

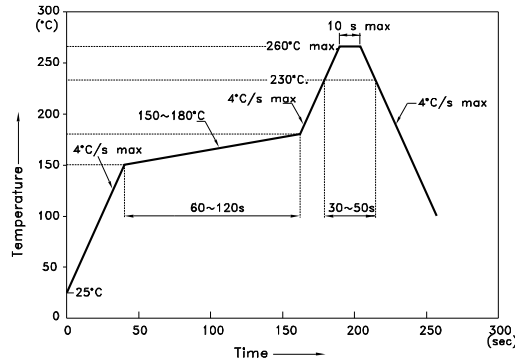
## APT1608SYCK-AMT



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Reflow soldering is recommended and the soldering profile is shown below.  
Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

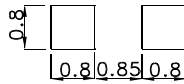


**NOTES:**

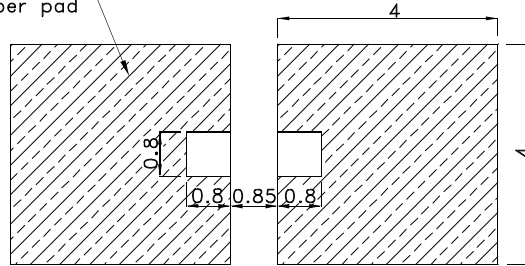
1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

### Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

Pad design for improved heat dissipation

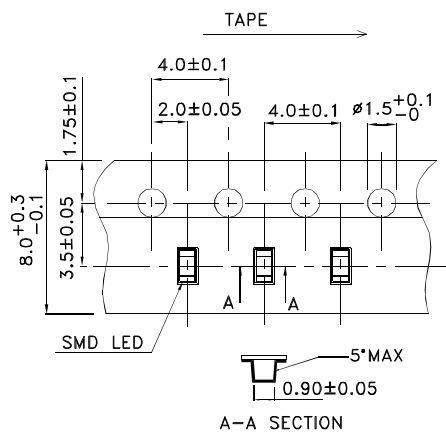


Cu-area > 16mm<sup>2</sup>  
per pad

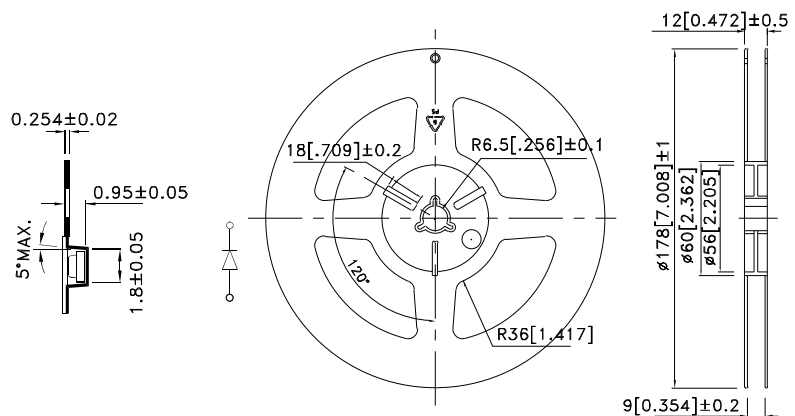


Solder resist

### Tape Specifications (Units : mm)

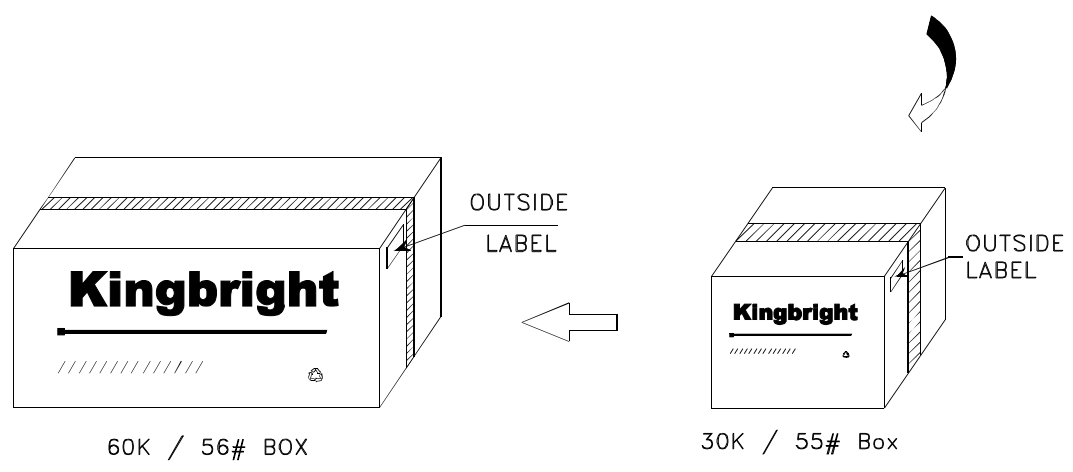
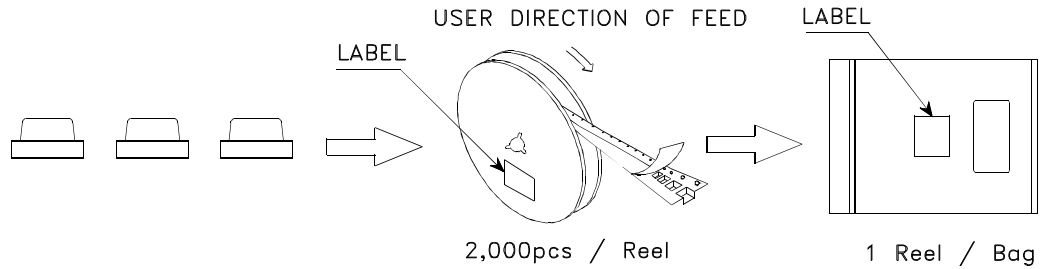



### Reel Dimension



**PACKING & LABEL SPECIFICATIONS**

**APT1608SYCK-AMT**



<h1>Kingbright</h1>	
P/NO: APT1608xxx	
QTY: 2,000 pcs	Q.C. <span style="border: 1px solid black; border-radius: 50%; padding: 2px;">Q C XX XX XXXX PASSED</span>
S/N: XXXX	
CODE: XXX	
LOT NO:	
 XXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	

## Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below

**Lot Tolerance Percent Defective (LTPD) : 10%**

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	Ta = 25°C ,IF = maximum rated current*	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	Ta = 100°C IF = maximum rated current*	1,000 h	0 / 22
3	Low Temp. operating test	-	Ta = -40°C, IF = maximum rated current*	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	Ta = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	Ta = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100(103)	Ta = 60°C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100(102)	Ta = 60°C, RH = 90% IF = maximum rated current*	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak : 30°C,70% RH, 72h Preheat : 150~180°C(120s max.) Soldering temp : 260°C(10s)	3 times	0 / 18
9	Thermal shock operating test	-	Ta = -40°C(15min) ~ 100°C(15min) IF = derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	Ta = -40°C(15min) ~ maximum rated storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	C = 100pF , R2 = 1.5KΩ V = 3000V	Once each Polarity	0 / 22
12	Vibration test	-	a = 196m/s <sup>2</sup> , f = 100~2KHz , t = 48min for all xyz axes	4 times	0 / 22

\* : Refer to forward current vs. derating curve diagram

## Failure Criteria

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	Iv	IF = 20mA	Testing Min. Value < Spec.Min.Value x 0.5
Forward Voltage	Vf	IF = 20mA	Testing Max. Value ≥ Spec.Max.Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥ Spec.Max.Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking